

Notice of References Cited	Application/Control No.	Applicant(s)/Patent Under Reexamination	
	10/006,777	GALVAGNI, JOHN L.	
	Examiner	Art Unit	Page 1 of 1
	Monica Lewis	2822	

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	W	Fabrication of a fully integrated...processes, 2000, Journal of Materials Science, 455-460
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A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.